7-102619-3 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 7-102619-3 PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 50

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

Connector & Contact Terminates To

Configuration Features

PCB Mount Header

Board-to-Board

Fully Shrouded

Printed Circuit Board



| Connector Contact Load Condition | Fully Loaded |
|---|--------------------------|
| PCB Mount Orientation | Vertical |
| Number of Positions | 50 |
| Number of Rows | 2 |
| Board-to-Board Configuration | Parallel |
| Electrical Characteristics | |
| Insulation Resistance | 5000 ΜΩ |
| Dielectric Withstanding Voltage (Max) | 750 Vrms |
| Body Features | |
| Connector Profile | |
| | Standard |
| Primary Product Color | Black |
| | |
| Primary Product Color | |
| Primary Product Color Contact Features | Black |
| Primary Product Color Contact Features Mating Square Post Dimension | Black .64 mm[.025 in] |

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



| Contact Underplating Material | Nickel |
|--|----------------------------|
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Phosphor Bronze |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Material Thickness | .381 μm[15 μin] |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Square Termination Post & Tail Dimension | .64 mm[.025 in] |
| Termination Post & Tail Length | 3.18 mm[.125 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Retention | With |
| Mating Retention Type | Detent Window |
| Mating Alignment | With |
| Mating Alignment Type | Polarization |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Housing Material | Thermoplastic |
| Dimensions | |
| Row-to-Row Spacing | 2.54 mm[.1 in] |
| PCB Thickness (Recommended) | 1.4 mm[.055 in] |
| Usage Conditions | |
| Housing Temperature Rating | Standard |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application | |
| Circuit Application | Signal |
| ndustry Standards | |
| Agency/Standard | CSA |

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



| Approved Standards | CSA LR7189, UL E28476 |
|--|---|
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| Packaging Quantity | 64 |
| Packaging Type | Package |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| EU RoHS Directive 2011/65/EU | Compliant |
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources. |
| Solder Process Capability | Wave solder capable to 240°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

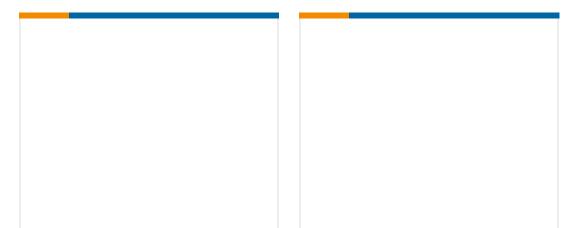
PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



TE Part # 1-88179-2 050 HOUSING FFC RCPT DR 100CL

Also in the Series AMPMODU Headers

| PCB Connector Mounting(1) | PCB Connector Shrouds(1) | PCB Headers & Receptacles(4875) | PCB Latches, Locks & Retainers(1) |
|---------------------------|--------------------------|---------------------------------|-----------------------------------|



Wire-to-Board Connector AssembliesWire-to-Board& Housings(5)

Wire-to-Board Connector Contacts(65)

Customers Also Bought

| TE Part #166053-1 COSI PIN CONTACT HD20 DF; 24-20 AWG | TE Part #102241-6 08 MODIV HSG COMP SR .100 POL | TE Part #1-770969-1 06P MINI UMNL R/A HDR ASSY LF | TE Part #1734193-1 WTB Socket,Terminal 80u" Tin |
|---|--|--|--|
| TE Part #350874-3 | TE Part #2-87631-9 | TE Part #440146-4 | TE Part #4-2176456-1 |
| UMNL SOK 18-14 .0125 PTPPHBZ | 34 MODIV HSG COMP DR .100 POL | 1.25mm WTB Socket,Housing,4p | CPF 0603 2R61 0.1% 25ppm 1K RL |

PCB Mount Header, Vertical, Board-to-Board, 50 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



TE Part #1614958-2 CPF 0805 1R0 0.1% 25ppm 1K RL

Documents

Product Drawings 50 MODII HDR DRST SHRD .100CL

English

CAD Files **Customer View Model** ENG_CVM_7-102619-3_K.3d_igs.zip

English

Customer View Model

ENG_CVM_7-102619-3_K.3d_stp.zip

English

Customer View Model

ENG_CVM_7-102619-3_K.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English

Product Environmental Compliance

Product Compliance

English

Product Compliance

English